

### **Preliminary Technical Information**

## **TrenchP™ Power MOSFET**

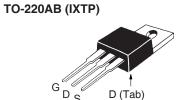
P-Channel Enhancement Mode Avalanche Rated

IXTA32P20T IXTP32P20T IXTQ32P20T IXTH32P20T

- 200V - 32A  $130 m\Omega$  $R_{DS(on)}$ 

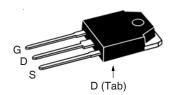








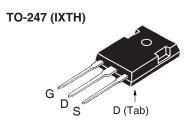
TO-3P	(IXTQ)



$\begin{array}{lll} \textbf{V}_{\text{DSS}} & \textbf{T}_{\text{J}} = 25^{\circ}\text{C to } 150^{\circ}\text{C} \\ \textbf{V}_{\text{DGR}} & \textbf{T}_{\text{J}} = 25^{\circ}\text{C to } 150^{\circ}\text{C},  \textbf{R}_{\text{GS}} = 1\text{M}\Omega \\ \\ \textbf{V}_{\text{GSS}} & \text{Continuous} \\ \textbf{V}_{\text{GSM}} & \text{Transient} \\ \\ \textbf{I}_{\text{D25}} & \textbf{T}_{\text{C}} = 25^{\circ}\text{C} \\ \textbf{I}_{\text{DM}} & \textbf{T}_{\text{C}} = 25^{\circ}\text{C},  \text{Pulse Width Limited by T}_{\text{JM}} \\ \\ \textbf{I}_{\text{A}} & \textbf{T}_{\text{C}} = 25^{\circ}\text{C} \\ \textbf{E}_{\text{AS}} & \textbf{T}_{\text{C}} = 25^{\circ}\text{C} \\ \end{array}$	- 200 - 200 <u>+</u> 15	V V
$\begin{array}{lll} \textbf{V}_{\text{DGR}} & \textbf{T}_{\text{J}} = 25^{\circ}\text{C to } 150^{\circ}\text{C, R}_{\text{GS}} = 1\text{M}\Omega \\ \\ \textbf{V}_{\text{GSS}} & \text{Continuous} \\ \\ \textbf{V}_{\text{GSM}} & \text{Transient} \\ \\ \textbf{I}_{\text{D25}} & \textbf{T}_{\text{C}} = 25^{\circ}\text{C} \\ \\ \textbf{I}_{\text{DM}} & \textbf{T}_{\text{C}} = 25^{\circ}\text{C, Pulse Width Limited by T}_{\text{JM}} \\ \\ \textbf{I}_{\text{A}} & \textbf{T}_{\text{C}} = 25^{\circ}\text{C} \\ \end{array}$	<u>+</u> 15	
$\begin{array}{lll} \textbf{V}_{\text{GSS}} & \text{Continuous} \\ \textbf{V}_{\text{GSM}} & \text{Transient} \\ \\ \textbf{I}_{\text{D25}} & \textbf{T}_{\text{C}} = 25^{\circ}\text{C} \\ \textbf{I}_{\text{DM}} & \textbf{T}_{\text{C}} = 25^{\circ}\text{C},  \text{Pulse Width Limited by T}_{\text{JM}} \\ \\ \textbf{I}_{\text{A}} & \textbf{T}_{\text{C}} = 25^{\circ}\text{C} \end{array}$	_	.,
$\begin{array}{ll} \textbf{V}_{\text{GSM}} & \text{Transient} \\ \\ \textbf{I}_{\text{D25}} & \textbf{T}_{\text{C}} = 25^{\circ}\text{C} \\ \\ \textbf{I}_{\text{DM}} & \textbf{T}_{\text{C}} = 25^{\circ}\text{C},  \text{Pulse Width Limited by T}_{\text{JM}} \\ \\ \textbf{I}_{\text{A}} & \textbf{T}_{\text{C}} = 25^{\circ}\text{C} \end{array}$	. 0.5	V
$\begin{split} \textbf{I}_{\text{D25}} & & & & & & & & & \\ \textbf{I}_{\text{DM}} & & & & & & & \\ \textbf{I}_{\text{DM}} & & & & & & & \\ \textbf{I}_{\text{C}} & = 25^{\circ}\text{C}, \text{ Pulse Width Limited by T}_{\text{JM}} \\ \textbf{I}_{\text{A}} & & & & & & & \\ \textbf{T}_{\text{C}} & = 25^{\circ}\text{C} \end{split}$	<u>+</u> 25	V
$I_A$ $T_C = 25^{\circ}C$	- 32	A
A 0	- 96	Α
$T_{c} = 25^{\circ}C$	- 32	A
	1	J
$P_{D}$ $T_{C} = 25^{\circ}C$	300	W
J	+150	°C
T <sub>.IM</sub>	150	°C
T <sub>stg</sub> -55	+150	°C
T <sub>1</sub> 1.6mm (0.062 in.) from Case for 10s	300	°C
T <sub>SOLD</sub> Plastic body for 10s	260	°C
<b>F</b> <sub>c</sub> Mounting Force (TO-263) 1065 / 2.2	214.6	N/lb.
Mounting Torque (TO-220, TO-247 & TO-3P) 1.	13 / 10	Nm/lb.in.
Weight TO-263	2.5	g
TO-220	3.0	g
TO-3P	5.5	~
TO-247	6.0	g

' <sub>J</sub>		-55	F130		C
T <sub>JM</sub>			150		$^{\circ}$ C
T <sub>stg</sub>		<b>-</b> 55	⊦150		°C
T,	1.6mm (0.062 in.) from Case for 10s		300		°C
T <sub>SOLD</sub>	Plastic body for 10s		260		°C
F <sub>c</sub>	Mounting Force (TO-263) 106	65 / 2.2	14.6	N	/lb.
M <sub>d</sub>	Mounting Torque (TO-220, TO-247 & TO-3P)	1.13	/ 10	Nm/II	o.in.
Weight	TO-263		2.5		g
	TO-220		3.0		g
	TO-3P		5.5		g
	TO-247		6.0		<u>g</u>
0	Total Complisions	Ohama	-4!-4!-	. Walasa	_
Symbol Test Conditions		Characteristic Values			5
$(T_J = 25^{\circ}C,$	Unless Otherwise Specified)	Min.	Тур.	Max.	
BV <sub>DSS</sub>	$V_{GS} = 0V$ , $I_D = -250\mu A$	- 200			V
V <sub>GS(th)</sub>	$V_{DS} = V_{GS}$ , $I_{D} = -250\mu A$	- 2.0		- 4.0	V
I <sub>gss</sub>	$V_{GS} = \pm 15V, V_{DS} = 0V$			±100	nA

T<sub>.1</sub> = 125°C



G	= Gate	D	=	Drain
S	= Source	Tab	=	Drain

#### **Features**

- International Standard Packages
- Avalanche Rated
- Extended FBSOA
- Fast Intrinsic Diode
- Low R<sub>DS(ON)</sub> and Q<sub>G</sub>

#### **Advantages**

- Easy to Mount
- Space Savings
- High Power Density

#### **Applications**

- High-Side Switching
- Push Pull Amplifiers
- DC Choppers

- 25 μA

-1.25 mA

130  $m\Omega$ 

- Automatic Test Equipment
- Current Regulators
- Battery Charger Applications

 $V_{DS} = V_{DSS}, V_{GS} = 0V$ 

 $V_{GS} = -10V$ ,  $I_D = 0.5 \cdot I_{D25}$ , Note 1

I<sub>DSS</sub>

 $R_{DS(on)}$ 



Symbol Test Conditions Char		Charac	racteristic Values		
$(T_J = 25)$	5°C, L	Inless Otherwise Specified)	Min.	Тур.	Max.
$\mathbf{g}_{fs}$		$V_{DS} = -10V, I_{D} = 0.5 \bullet I_{D25}, \text{ Note 1}$	18	30	S
C <sub>iss</sub>	)			14.5	nF
$\mathbf{C}_{oss}$	}	$V_{GS} = 0V, V_{DS} = -25V, f = 1MHz$		565	pF
C <sub>rss</sub>	J			105	pF
t <sub>d(on)</sub>	)	Resistive Switching Times		32	ns
t <sub>r</sub>		$V_{GS} = -10V$ , $V_{DS} = 0.5 \cdot V_{DSS}$ , $I_{D} = 0.5 \cdot I_{D25}$		15	ns
$\mathbf{t}_{d(off)}$	7			57	ns
t <sub>f</sub>	, J	$R_{g} = 1\Omega$ (External)		12	ns
$\mathbf{Q}_{g(on)}$	}			185	nC
$\mathbf{Q}_{gs}$		$V_{GS} = -10V, V_{DS} = 0.5 \cdot V_{DSS}, I_{D} = 0.5 \cdot I_{D25}$		66	nC
$\mathbf{Q}_{gd}$				45	nC
R <sub>thJC</sub>					0.42 °C/W
$\mathbf{R}_{ ext{thCS}}$		TO-220		0.50	°C/W
		TO-247 &TO-3P		0.21	°C/W

#### Source-Drain Diode

Symbol	Symbol Test Conditions Characteristic Value			<b>Values</b>	;
$(T_J = 25^{\circ}C, Unless Otherwise Specified)$		Min.	Тур.	Max.	
I <sub>s</sub>	$V_{GS} = 0V$			- 32	Α
SM	Repetitive, Pulse Width Limited by $\mathrm{T_{_{JM}}}$			- 128	A
V <sub>SD</sub>	$I_F = -32A, V_{GS} = 0V, \text{ Note } 1$			-1.3	V
$\left\{egin{array}{c} \mathbf{t}_{rr} & \ \mathbf{Q}_{RM} \ \mathbf{I}_{RM} \end{array} ight. \right\}$	$I_F = -16A$ , $-di/dt = -100A/\mu s$ $V_R = -100V$ , $V_{GS} = 0V$		190 1.7 -17.8		ns µC A

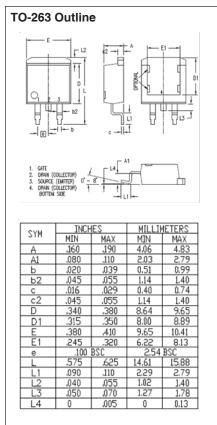
1: Pulse test,  $t \le 300\mu s$ , duty cycle,  $d \le 2\%$ . Note

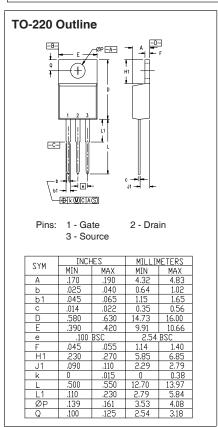
#### PRELIMINARY TECHNICAL INFORMATION

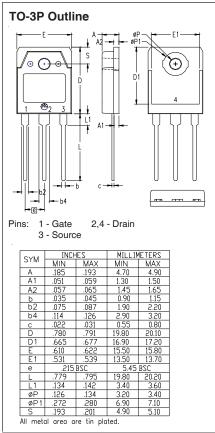
The product presented herein is under development. The Technical Specifications offered are derived from data gathered during objective characterizations of preliminary engineering lots; but also may yet contain some information supplied during a pre-production design evaluation. IXYS reserves the right to change limits, test conditions, and dimensions without notice.



# IXTA32P20T IXTQ32P20T IXTP32P20T IXTH32P20T







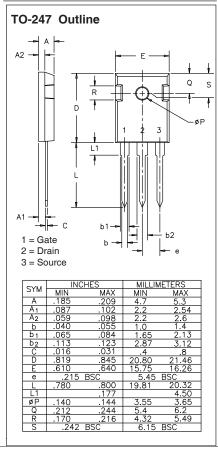


Fig. 1. Output Characteristics @ T<sub>J</sub> = 25°C

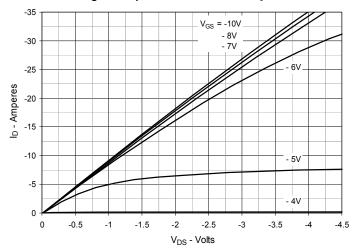


Fig. 2. Extended Output Characteristics @ T<sub>J</sub> = 25°C

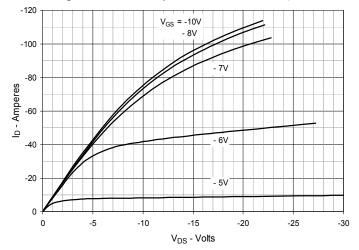


Fig. 3. Output Characteristics @ T<sub>J</sub> = 125°C

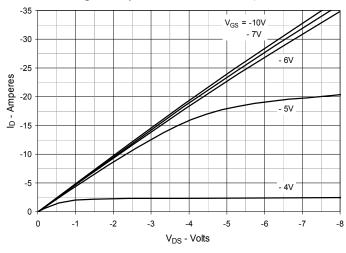


Fig. 4.  $R_{DS(on)}$  Normalized to  $I_D = -16A$  vs.

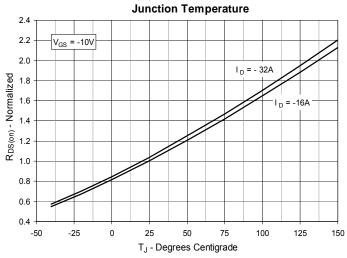


Fig. 5.  $R_{DS(on)}$  Normalized to  $I_D = -16A$  vs.

Drain Current

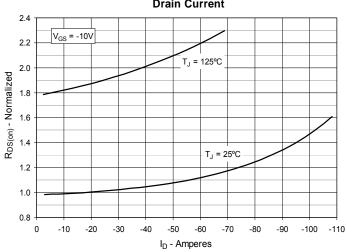
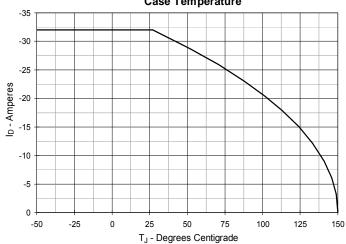


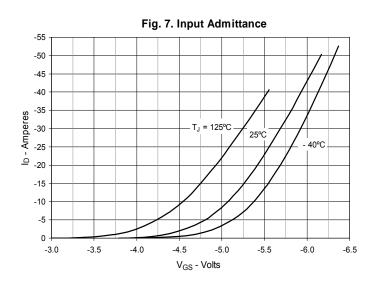
Fig. 6. Maximum Drain Current vs.

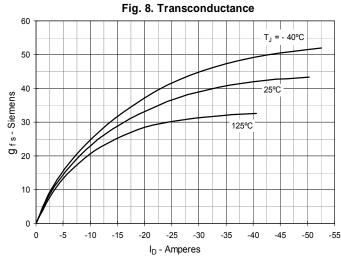
Case Temperature

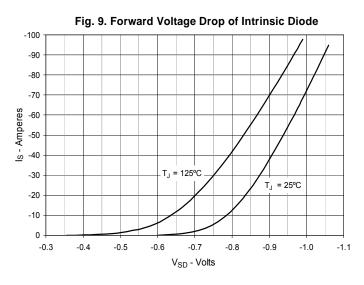


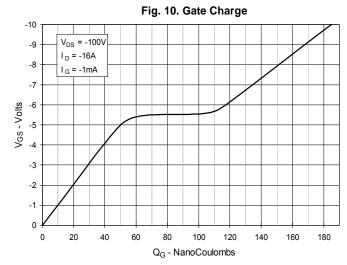
IXYS Reserves the Right to Change Limits, Test Conditions, and Dimensions.

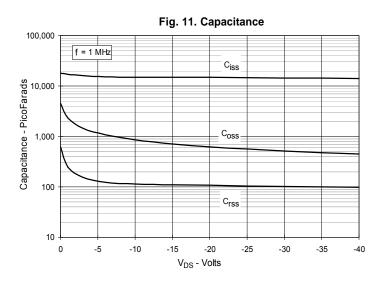












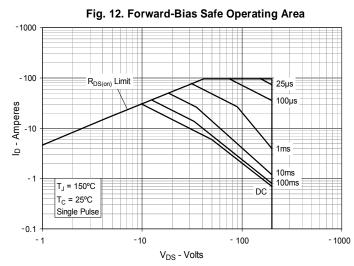




Fig. 13. Resistive Turn-on Rise Time vs.
Junction Temperature

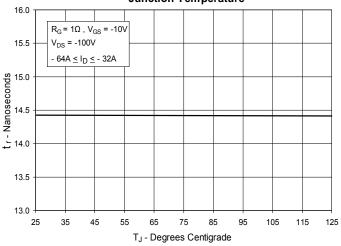


Fig. 14. Resistive Turn-on Rise Time vs.

Drain Current

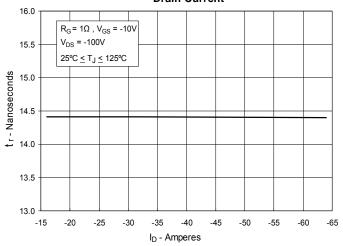


Fig. 15. Resistive Turn-on Switching Times vs.

Gate Resistance

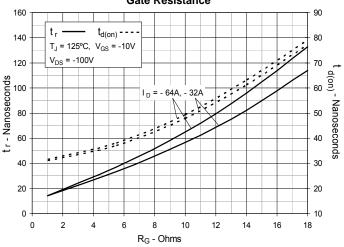


Fig. 16. Resistive Turn-off Switching Times vs.

Junction Temperature

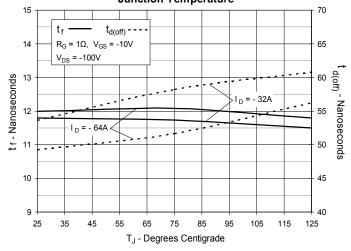


Fig. 17. Resistive Turn-off Switching Times vs.

Drain Current

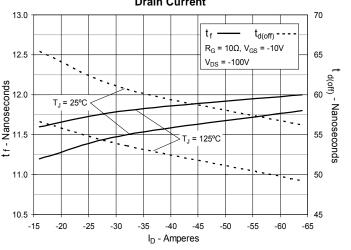
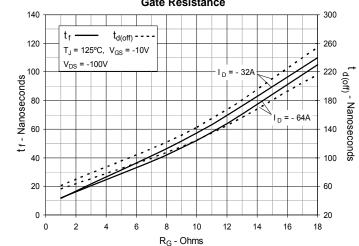
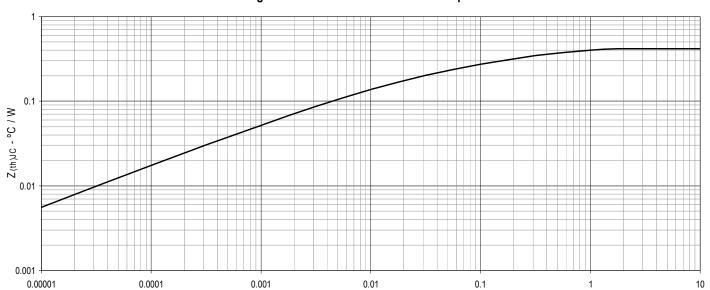


Fig. 18. Resistive Turn-off Switching Times vs.
Gate Resistance



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Pulse Width - Seconds

Fig. 19. Maximum Transient Thermal Impedance